8-Bit Addressable Latch

The MC74AC259/74ACT259 is a high-speed 8-bit addressable latch designed for general purpose storage applications in digital systems. It is a multifunctional device capable of storing single line data in eight addressable latches, and also a 1-of-8 decoder and demultiplexer with active HIGH outputs. The device also incorporates an active LOW Common Clear for resetting all latches, as well as an active LOW Enable. It is functionally identical to the ALS259 8-bit addressable latch.

- Serial-to-Parallel Conversion
- Eight Bits of Storage with Output of Each Bit Available
- Random (Addressable) Data Entry
- Active High Demultiplexing or Decoding Capability
- Easily Expandable
- Common Clear
- These are Pb–Free Devices

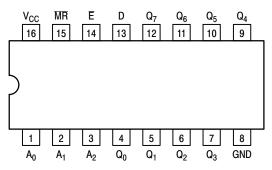


Figure 1. Pinout: 16–Lead Packages Conductors

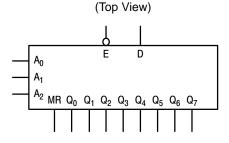


Figure 2. Logic Symbol

MODE SELECT TABLE

E	MR	Mode						
L	Н	Addressable Latch						
н	н	Memory						
L	L	Active HIGH 8–Channel Demultiplexer						
Н	L	Clear						

H = HIGH Voltage Level

L = LOW Voltage Level



ON Semiconductor®

www.onsemi.com

	MARKING DIAGRAM
16	SOIC-16 D SUFFIX CASE 751B 10 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0
XXX A WL Y WW G	= AC or ACT = Assembly Location = Wafer Lot = Year = Work Week = Pb-Free Package

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 8 of this data sheet.

Operating			Inp	uts						Out	puts			
Mode	MR	Ē	D	A_0	A ₁	A_2	Q ₀	Q ₁	Q_2	Q_3	Q_4	Q_5	Q_6	Q ₇
Master Reset	L	Н	Х	Х	Х	Х	L	L	L	L	L	L	L	L
	L	L	d	L	L	L	Q = d	L	L	L	L	L	L	L
	L	L	d	Н	L	L	L	Q = d	L	L	L	L	L	L
Demultiplex	L	L	d	L	Н	L	L	L	Q = d	L	L	L	L	L
(Active HIGH Decoder when	•	•	•	•	•	•	•	•	•	•	•	•	•	•
D = H	•	•	•	•	•	•	•	•	•	•	•	•	•	•
,	•	•	•	•	•	•	•	•	•	•	•	•	•	•
	L	L	d	Н	Н	Н	L	L	L	L	L	L	L	Q = d
Store (Do Nothing)	н	Н	х	х	х	х	q ₀	q ₁	q ₂	q ₃	q ₄	q ₅	q 6	q ₇
	н	L	d	L	L	L	Q = d	q ₁	q ₂	q ₃	q ₄	q ₅	q ₆	q ₇
	н	L	d	Н	L	L	q ₀	Q = d	q ₂	q ₃	q_4	q ₅	q 6	q ₇
Addressable	н	L	d	L	Н	L	q ₀	q 1	Q = d	q ₃	q ₄	q ₅	q ₆	q ₇
Latch	•	•	•	•	•	•	•	•	•	•	•	•	•	•
Laton	•	•	٠	•	٠	•	•	•	•	•	•	•	•	•
	•	٠	•	•	•	•	•	•	•	•	•	•	•	•
	Н	L	d	Н	Н	Н	q ₀	q ₁	q ₂	q ₃	q ₄	q ₅	q_6	Q = d

MODE SELECT-FUNCTION TABLE

H = HIGH Voltage Level

L = LOW Voltage Level

X = Immaterial

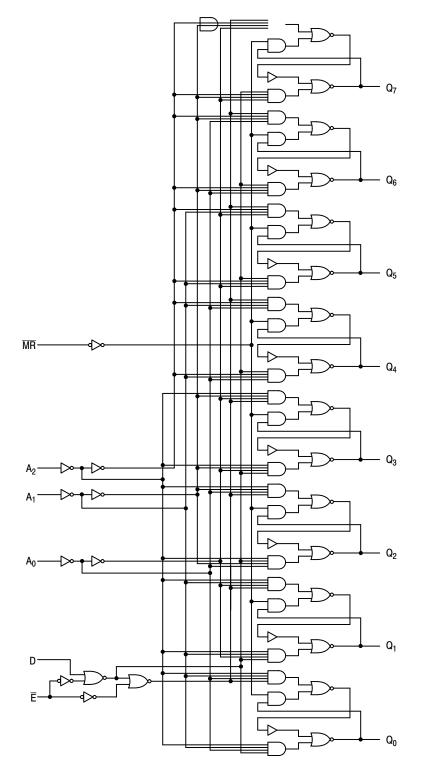
d = HIGH or LOW Data one setup time prior to the LOW-to-HIGH Enable transition

q = Lower case letters indicate the state of the referenced output established during the last cycle in which it was addressed or cleared

FUNCTIONAL DESCRIPTION

The MC74AC259/74ACT259 has four modes of operation as shown in the Mode Selection Table. In the addressable latch mode, data on the Data line (D) is written into the addressed latch. The addressed latch will follow the data input with all non–addressed latches remaining in their previous states in the memory mode. All latches remain in their previous state and are unaffected by the Data or Address inputs.

In the one–of–eight decoding or demultiplexing mode, the addressed output will follow the state of the D input with all other outputs in the LOW state. In the clear mode all outputs are LOW and unaffected by the address and data inputs. When operating the MC74AC/ACT259 as an addressable latch, changing more than one bit of the address could impose a transient wrong address. Therefore, this should only be done while in the memory mode. The Mode Select Function Table summarizes the operations of the MC74AC/ACT259.



NOTE: This diagram is provided only for the understanding of logic operations and should not be used to estimate propagation delays.

Figure 3. Logic Diagram

MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V _{CC}	DC Supply Voltage	-0.5 to +7.0	V
VI	DC Input Voltage	$-0.5 \le V_{CC}$ +0.5	V
Vo	DC Output Voltage (Note 1)	$-0.5 \leq V_{CC}$ +0.5	V
I _{IK}	DC Input Diode Current	±20	mA
I _{OK}	DC Output Diode Current	±50	mA
I _O	DC Output Sink/Source Current	±50	mA
I _{CC}	DC Supply Current per Output Pin	±50	mA
I _{GND}	DC Ground Current per Output Pin	±50	mA
T _{STG}	Storage Temperature Range	-65 to +150	°C
TL	Lead temperature, 1 mm from Case for 10 Seconds	260	°C
TJ	Junction temperature under Bias	+150	°C
θ_{JA}	Thermal Resistance (Note 2)	69.1	°C/W
P _D	Power Dissipation in Still Air at 65°C (Note 3)	500	mW
MSL	Moisture Sensitivity	Level 1	
F _R	Flammability Rating Oxygen Index: 30% – 35%	UL 94 V–0 @ 0.125 in	
V _{ESD}	ESD Withstand Voltage Human Body Model (Note 4) Machine Model (Note 5) Charged Device Model (Note 6)	> 2000 > 200 > 1000	V
I _{Latch-Up}	Latch–Up Performance Above V _{CC} and Below GND at 85°C (Note 7)	±100	mA

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. I_O absolute maximum rating must be observed.

2. The package thermal impedance is calculated in accordance with JESD51-7.

3. 500 mW at 65°C; derate to 300 mW by 10 mW/ from 65°C to 85°C.

4. Tested to EIA/JESD22-A114-A.

5. Tested to EIA/JESD22-A115-A.

Tested to JESD22-C101-A. 6.

7. Tested to EIA/JESD78.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter		Min	Тур	Max	Unit
	Oursely Mallane	′AC	2.0	5.0	6.0	
V _{CC}	Supply Voltage	′ACT	4.5	5.0	5.5	V
V _{IN} , V _{OUT}	DC Input Voltage, Output Voltage (Ref. to GND)	0	-	V _{CC}	V	
		V _{CC} @ 3.0 V	-	150	-	
t _r , t _f	Input Rise and Fall Time (Note 1) 'AC Devices except Schmitt Inputs	V _{CC} @ 4.5 V	_	40	-	ns/V
		V _{CC} @ 5.5 V	_	25	-	
	Input Rise and Fall Time (Note 2)	V _{CC} @ 4.5 V	_	10	-	\\ /
t _r , t _f	'ACT Devices except Schmitt Inputs	V _{CC} @ 5.5 V	_	8.0	-	ns/V
T _A	Operating Ambient Temperature Range	-40	25	85	°C	
I _{OH}	Output Current – High			-	-24	mA
I _{OL}	Output Current – Low			-	24	mA

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

1. V_{IN} from 30% to 70% V_{CC} ; see individual Data Sheets for devices that differ from the typical input rise and fall times. 2. V_{IN} from 0.8 V to 2.0 V; see individual Data Sheets for devices that differ from the typical input rise and fall times.

DC CHARACTERISTICS

			74	AC	74AC		
Symbol	Parameter	V _{CC} (V)	T _A = -	+25°C	T _A =–40°C to +85°C	Unit	Conditions
		(•)	Тур	G	uaranteed Limits		
V _{IH}	Minimum High Level Input Voltage	3.0 4.5 5.5	1.5 2.25 2.75	2.1 3.15 3.85	2.1 3.15 3.85	V	$V_{OUT} = 0.1 V$ or $V_{CC} - 0.1 V$
V _{IL}	Maximum Low Level Input Voltage	3.0 4.5 5.5	1.5 2.25 2.75	0.9 1.35 1.65	0.9 1.35 1.65	V	$V_{OUT} = 0.1 V$ or $V_{CC} - 0.1 V$
V _{OH}	Minimum High Level Output Voltage	3.0 4.5 5.5	2.99 4.49 5.49	2.9 4.4 5.4	2.9 4.4 5.4	V	I _{OUT} = -50 μA
		3.0 4.5 5.5	- - -	2.56 3.86 4.86	2.46 3.76 4.76	V	$V_{IN} = V_{IL} \text{ or } V_{IH}$ -12 mA I_{OH} -24 mA -24 mA
V _{OL}	Maximum Low Level Output Voltage	3.0 4.5 5.5	0.002 0.001 0.001	0.1 0.1 0.1	0.1 0.1 0.1	V	I _{OUT} = 50 μA
		3.0 4.5 5.5		0.36 0.36 0.36	0.44 0.44 0.44	V	$V_{IN} = V_{IL} \text{ or } V_{IH}$ 12 mA I_{OL} 24 mA 24 mA
I _{IN}	Maximum Input Leakage Current	5.5	-	±0.1	±1.0	μΑ	$V_{I} = V_{CC}, GND$
I _{OLD}	†Minimum Dynamic	5.5	-	-	75	mA	V _{OLD} = 1.65 V Max
I _{OHD}	Output Current	5.5	-	-	-75	mA	V _{OHD} = 3.85 V Min
Icc	Maximum Quiescent Supply Current	5.5	_	8.0	80	μA	$V_{IN} = V_{CC}$ or GND

*All outputs loaded; thresholds on input associated with output under test. †Maximum test duration 2.0 ms, one output loaded at a time.

NOTE: I_{IN} and I_{CC} @ 3.0 V are guaranteed to be less than or equal to the respective limit @ 5.5 V V_{CC}.

				74AC		74	AC		
Symbol	Parameter	V _{CC} * (V)		_A = +25° _L = 50 p		T _A = −40°C to +85°C C _L = 50 pF		Unit	Fig. No.
			Min	Тур	Max	Min	Max		
t _{PLH}	Propagation Delay D_n to Q_n	3.3 5.0	2.0 2.0	9.0 6.5	14.5 10.0	1.5 1.5	17.0 11.5	ns	3–5
t _{PHL}	Propagation Delay D_n to Q_n	3.3 5.0	2.0 2.0	9.0 6.0	13.5 9.5	1.5 1.5	16.0 11.0	ns	3–5
t _{PLH}	Propagation Delay E to Q _n	3.3 5.0	2.0 2.0	10.5 7.0	15.0 10.5	1.5 1.5	17.5 12.5	ns	3–6
t _{PHL}	Propagation Delay E to Q _n	3.3 5.0	2.0 2.0	8.0 7.5	12.5 9.0	1.5 1.5	15.0 11.0	ns	3–6
t _{PLH}	Propagation Delay Address to Q _n	3.3 5.0	2.0 2.0	12.0 8.0	19.0 13.0	1.5 1.5	22.5 15.5	ns	3–6
t _{PHL}	Propagation Delay Address to Q _n	3.3 5.0	2.0 2.0	10.0 7.0	16.0 11.0	1.5 1.5	19.0 13.0	ns	3–6
t _{PHL}	Propagation Delay MR to Q	3.3 5.0	2.0 2.0	8.0 6.0	12.0 9.0	1.5 1.5	13.5 10.0	ns	3–7

AC CHARACTERISTICS (For Figures and Waveforms – See Section 3 of the ON Semiconductor FACT Data Book, DL138/D)

*Voltage Range 3.3 V is 3.3 V ± 0.3 V. *Voltage Range 5.0 V is 5.0 V ± 0.5 V.

AC OPERATING REQUIREMENTS

				74AC	74AC		
Symbol	Parameter	V _{CC} * (V)	T _A = +25°C C _L = 50 pF		$T_{A} = -40^{\circ}C \text{ to } +85^{\circ}C$ $C_{L} = 50 \text{ pF}$	Unit	Fig. No.
	Тур		Guaran	Guaranteed Minimum			
t _s	Setup Time, HIGH or LOW D _n to E	3.3 5.0	-	3.5 2.5	4.5 3.5	ns	3–9
t _h	Hold Time, HIGH or LOW D_n to \overline{E}	3.3 5.0	-	2.5 2.0	2.5 2.0	ns	3–9
t _s	Setup Time Address to E	3.3 5.0	-	7.0 4.0	9.0 6.0	ns	3–6
t _h	Hold Time Address to \overline{E}	3.3 5.0		2.0 2.0	2.0 2.0	ns	3–6
tw	Minimum Pulse Width MR	3.3 5.0	-	6.0 5.5	6.5 6.0	ns	3–6
tw	Minimum Pulse Width E	3.3 5.0	-	6.5 5.5	7.0 6.0	ns	3–6

*Voltage Range 3.3 V is 3.3 V ± 0.3 V. *Voltage Range 5.0 V is 5.0 V ± 0.5 V.

DC CHARACTERISTICS

			74	АСТ	74ACT		
Symbol	Parameter	V _{CC} (V)	T _A = -	+25°C	$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$	Unit	Conditions
		(,,	Тур	G	uaranteed Limits		
V _{IH}	Minimum High Level Input Voltage	4.5 5.5	1.5 1.5	2.0 2.0	2.0 2.0	V	$V_{OUT} = 0.1 V$ or $V_{CC} - 0.1 V$
V _{IL}	Maximum Low Level Input Voltage	4.5 5.5	1.5 1.5	0.8 0.8	0.8 0.8	V	$V_{OUT} = 0.1 V$ or $V_{CC} - 0.1 V$
V _{OH}	Minimum High Level Output Voltage	4.5 5.5	4.49 5.49	4.4 5.4	4.4 5.4	V	I _{OUT} = -50 μA
		4.5 5.5		3.86 4.86	3.76 4.76	V	$V_{IN} = V_{IL} \text{ or } V_{IH}$ -24 mA I_{OH} -24 mA
V _{OL}	Maximum Low Level Output Voltage	4.5 5.5	0.001 0.001	0.1 0.1	0.1 0.1	V	I _{OUT} = 50 μA
		4.5 5.5		0.36 0.36	0.44 0.44	V	$V_{IN} = V_{IL} \text{ or } V_{IH}$ 24 mA I_{OL} 24 mA
I _{IN}	Maximum Input Leakage Current	5.5	-	±0.1	±1.0	μΑ	$V_{I} = V_{CC}, GND$
ΔI_{CCT}	Additional Max. I _{CC} /Input	5.5	0.6	-	1.5	mA	$V_{I} = V_{CC} - 2.1 V$
I _{OLD}	†Minimum Dynamic	5.5	-	-	75	mA	V _{OLD} = 1.65 V Max
I _{OHD}	Output Current	5.5	-	-	-75	mA	V _{OHD} = 3.85 V Min
I _{CC}	Maximum Quiescent Supply Current	5.5	_	8.0	80	μA	$V_{IN} = V_{CC}$ or GND

*All outputs loaded; thresholds on input associated with output under test. †Maximum test duration 2.0 ms, one output loaded at a time.

AC CHARACTERISTICS (For Figures and Waveforms - See Section 3 of the ON Semiconductor FACT Data Book, DL138/D)

	Parameter	V _{CC} * (V)	74ACT T _A = +25°C C _L = 50 pF			74A	СТ		
Symbol						$T_{A} = -40^{\circ}C \text{ to } +85^{\circ}C$ $C_{L} = 50 \text{ pF}$		Unit	Fig. No.
			Min	Тур	Max	Min	Max		
t _{PLH}	Propagation Delay D _n to Q _n	5.0	2.0	6.5	11.0	1.5	12.5	ns	3–5
t _{PHL}	Propagation Delay D _n or Q _n	5.0	2.0	7.0	10.5	1.5	12.0	ns	3–5
t _{PLH}	Propagation Delay \overline{E} to Q_n	5.0	2.0	10.5	14.0	1.5	16.5	ns	3–6
t _{PHL}	Propagation Delay E or Q _n	5.0	2.0	9.0	12.0	1.5	14.0	ns	3–6
t _{PLH}	Propagation Delay Address to Q _n	5.0	2.0	8.0	11.5	1.5	13.5	ns	3–6
t _{PHL}	Propagation Delay Address to Q _n	5.0	2.0	6.0	10.0	1.5	12.0	ns	3–6
t _{PHL}	Propagation Delay MR to Q	5.0	2.0		10.0	1.5	11.0	ns	3–7

*Voltage Range 5.0 V is 5.0 V \pm 0.5 V.

AC OPERATING REQUIREMENTS

				74ACT	74ACT		
Symbol	Parameter	V _{CC} * (V)	T _A = +25°C C _L = 50 pF		T _A = −40°C to +85°C C _L = 50 pF	Unit	Fig. No.
			Тур	Guarar	nteed Minimum		
t _s	Setup Time, HIGH or LOW D_n to \overline{E}	5.0	I	3.0	4.0	ns	3–9
t _h	Hold Time, HIGH or LOW D_n to \overline{E}	5.0	I	2.5	2.5	ns	3–9
t _s	Setup Time Address to \overline{E}	5.0	I	4.5	6.5	ns	3–6
t _h	Hold Time Address to \overline{E}	5.0	I	2.5	2.5	ns	3–6
tw	Minimum Pulse Width MR	5.0	-	7.0	7.5	ns	3–6
t _w	Minimum Pulse Width Ē	5.0	_	7.0	7.5	ns	3–6

*Voltage Range 5.0 V is 5.0 V ± 0.5 V.

CAPACITANCE

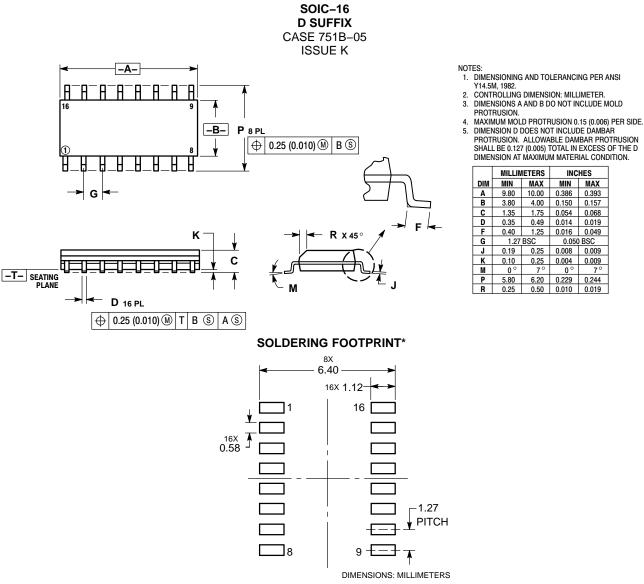
Symbol	Parameter	Value Typ	Unit	Test Conditions
C _{IN}	Input Capacitance	4.5	pF	$V_{CC} = 5.0 V$
C _{PD}	Power Dissipation Capacitance	50.0	pF	V _{CC} = 5.0 V

ORDERING INFORMATION

Part Number	Package	Shipping [†]
MC74AC259DG	SOIC-16 (Pb-Free)	48 Units / Rail
MC74AC259DR2G	SOIC-16 (Pb-Free)	2500 / Tape & Reel
MC74ACT259DG	SOIC-16 (Pb-Free)	48 Units / Rail
MC74ACT259DR2G	SOIC-16 (Pb-Free)	2500 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

PACKAGE DIMENSIONS



*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

ON Semiconductor and the an are registered trademarks of Semiconductor Components Industries, LLC (SCILLC) or its subsidiaries in the United States and/or other countries. SCILLC owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of SCILLC's product/patent coverage may be accessed at www.onsemi.com/site/pdt/Patent-Marking.pdf. SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product series as altione personal injury or death may occur. Should Buyer purchase or use SCILLC brows ther application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT

Literature Distribution Center for ON Semiconductor P.O. Box 5163, Denver, Colorado 80217 USA Phone: 303–675–2175 or 800–344–3860 Toll Free USA/Canada Fax: 303–675–2176 or 800–344–3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800–282–9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support:

Phone: 421 33 790 2910 Japan Customer Focus Center Phone: 81–3–5817–1050 ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

ON Semiconductor: MC74AC259DG MC74AC259DR2G MC74ACT259DG MC74ACT259DR2G